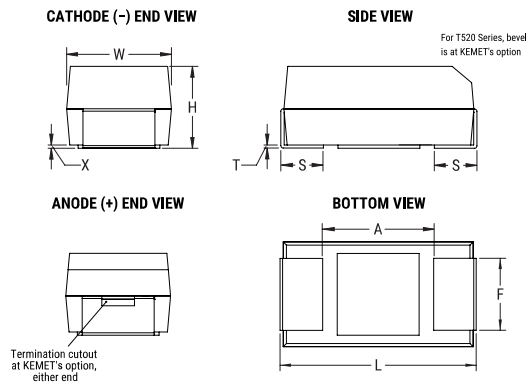


T520, Tantalum, Polymer Tantalum, 330 uF, 20%, 2.5 VDC, SMD, Polymer, Molded, Low Profile/ESR, NonCombustible, 40 mOhms, 7343, Height Max = 1.9mm



| General Information | |
|---------------------|---|
| Supplier: | KEMET |
| Series: | T520 |
| Dielectric: | Polymer Tantalum |
| Style: | SMD Chip |
| Description: | SMD, Polymer, Molded, Low Profile/ESR, NonCombustible |
| Features: | Low ESR |
| RoHS: | Yes |
| Termination: | Tin |
| Shelf Life: | 52 Weeks |
| MSL: | 3 |

| Dimensions | |
|------------|----------------|
| Footprint | 7343 |
| L | 7.3mm +/-0.3mm |
| W | 4.3mm +/-0.3mm |
| H | 1.8mm +/-0.1mm |
| T | 0.13mm REF |
| S | 1.3mm +/-0.3mm |
| F | 2.4mm +/-0.1mm |
| A | 3.6mm MIN |
| X | 0.05mm REF |

| Specifications | |
|------------------------|--|
| Capacitance: | 330 uF |
| Capacitance Tolerance: | 20% |
| Voltage DC: | 2.5 VDC (105C) |
| Temperature Range: | -55/+105C |
| Rated Temperature: | 105C |
| Dissipation Factor: | 10.00% 120Hz 25C |
| Failure Rate: | N/A |
| Resistance: | 40 mOhms (100kHz 25C) |
| Ripple Current: | 2200 mA (100kHz 45C), 1540 mA (85C), 550 mA (105C) |
| Leakage Current: | 82.5 uA (5min 25C) |

| Packaging Specifications | |
|--------------------------|------------|
| Weight: | 274.3 mg |
| Packaging: | T&R, 178mm |
| Packaging Quantity: | 1000 |

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